

6A, 700V N-CHANNEL MOSFET

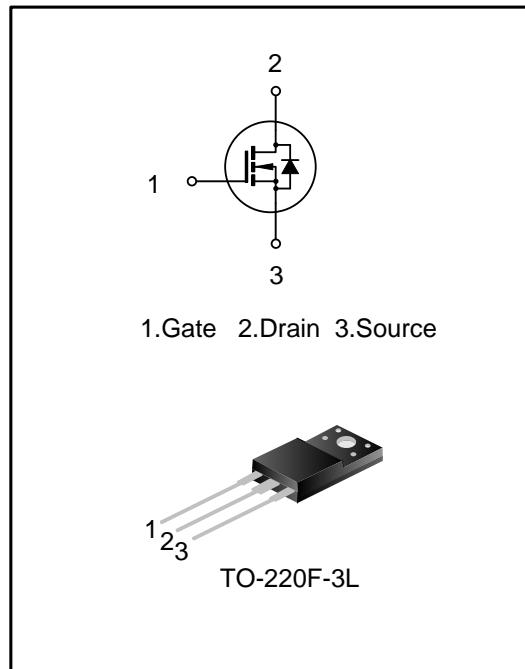
GENERAL DESCRIPTION

SVF6N70F is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power suppliers, DC-DC converters and H-bridge PWM motor drivers.

FEATURES

- 6A, 700V, $R_{DS(on)(typ.)}=1.35\Omega$ @ $V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVF6N70F	TO-220F-3L	SVF6N70F	Pb free	Tube



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ C$ UNLESS OTHERWISE NOTED)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		V_{DS}	700	V
Gate-Source Voltage		V_{GS}	± 30	V
Drain Current	$T_C=25^\circ C$	I_D	6.0	A
	$T_C=100^\circ C$		3.79	
Drain Current Pulsed		I_{DM}	24.0	A
Power Dissipation($T_C=25^\circ C$) -Derate above $25^\circ C$		P_D	45	W
			0.36	W/ $^\circ C$
Single Pulsed Avalanche Energy(Note 1)		E_{AS}	463	mJ
Operation Junction Temperature Range		T_J	-55~+150	$^\circ C$
Storage Temperature Range		T_{stg}	-55~+150	$^\circ C$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.78	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ C/W$

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ C$ UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	700	--	--	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=700V, V_{GS}=0V$	--	--	1.0	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30V, V_{DS}=0V$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	--	4.0	V
Static Drain- Source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=3.0A$	--	1.35	1.7	Ω
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	--	1039	--	pF
Output Capacitance	C_{oss}		--	98	--	
Reverse Transfer Capacitance	C_{rss}		--	3.9	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=350V, I_D=6.0A, R_G=25\Omega$, $(Note 2,3)$	--	24	--	ns
Turn-on Rise Time	t_r		--	37	--	
Turn-off Delay Time	$t_{d(off)}$		--	68	--	
Turn-off Fall Time	t_f		--	37	--	
Total Gate Charge	Q_g	$V_{DS}=560V, I_D=6.0A,$ $V_{GS}=10V,$ $(Note 2,3)$	--	22	--	nC
Gate-Source Charge	Q_{gs}		--	6.1	--	
Gate-Drain Charge	Q_{gd}		--	8.8	--	



SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

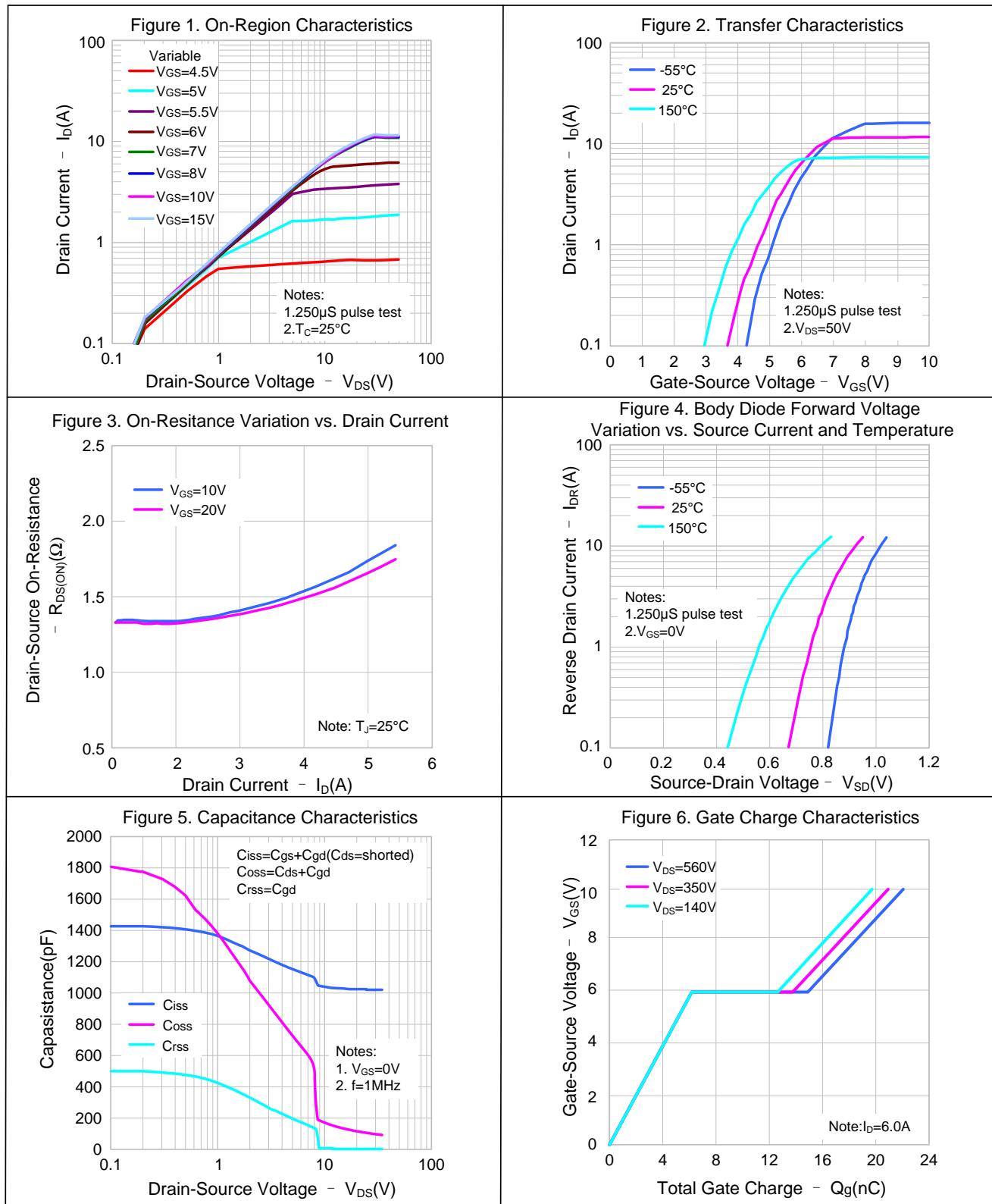
Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I _S	Integral Reverse P-N Junction Diode in the MOSFET	--	--	6.0	A
Pulsed Source Current	I _{SM}		--	--	24	
Diode Forward Voltage	V _{SD}	I _S =6.0A, V _{GS} =0V	--	--	1.4	V
Reverse Recovery Time	T _{rr}	I _S =6.0A, V _{GS} =0V, dI _F /dt=100A/μs (Note 2)	--	494	--	ns
Reverse Recovery Charge	Q _{rr}		--	3.4	--	μC

Notes:

1. L=30mH, I_{AS}=5.00A, V_{DD}=100V, R_G=25Ω, starting T_{BJB}=25°C;
2. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
3. Essentially independent of operating temperature.



TYPICAL CHARACTERISTICS





TYPICAL CHARACTERISTICS(CONTINUED)

Figure 7. Breakdown Voltage Variation vs. Temperature

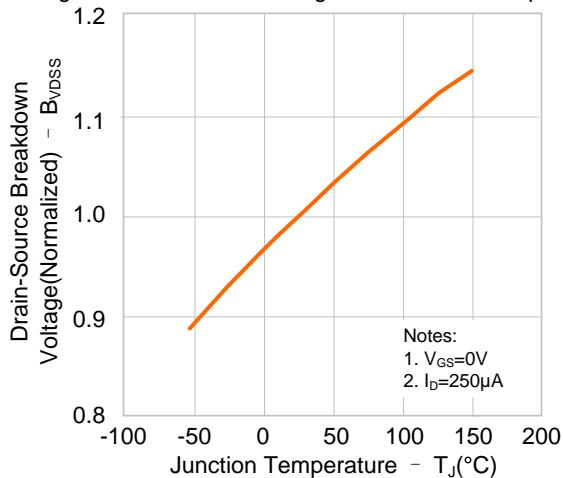


Figure 8. On-resistance Variation vs. Temperature

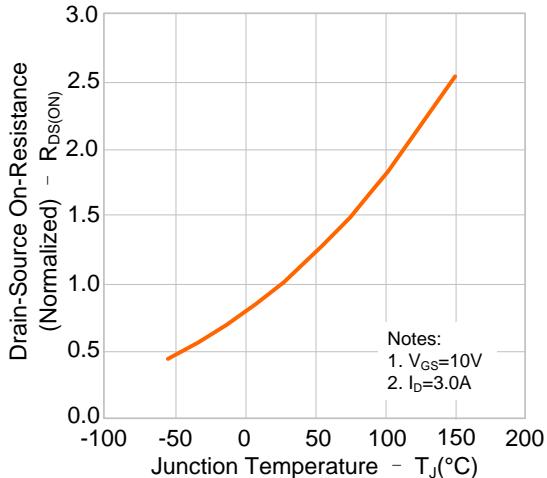


Figure 9. Max. Safe Operating Area

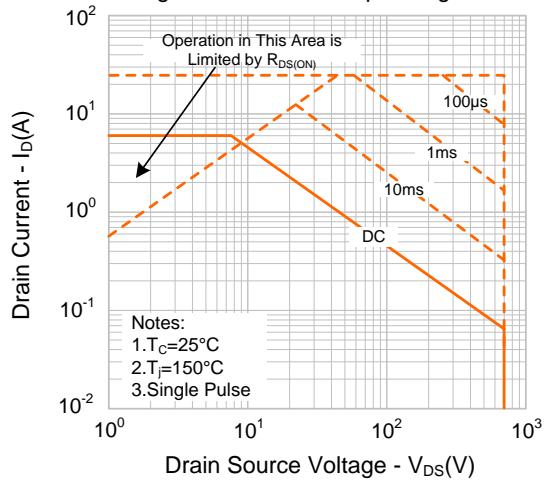
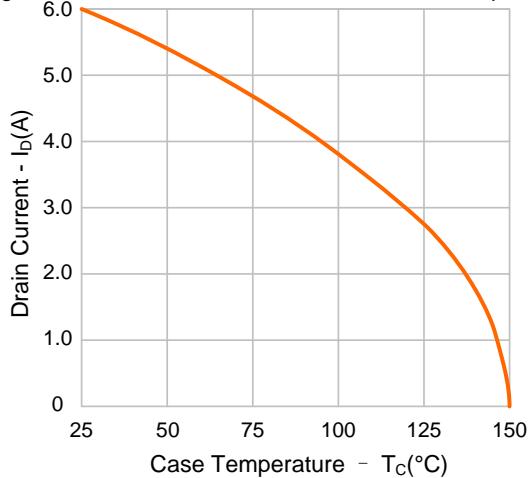
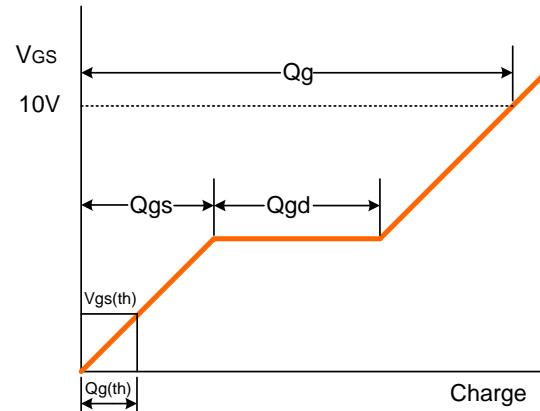
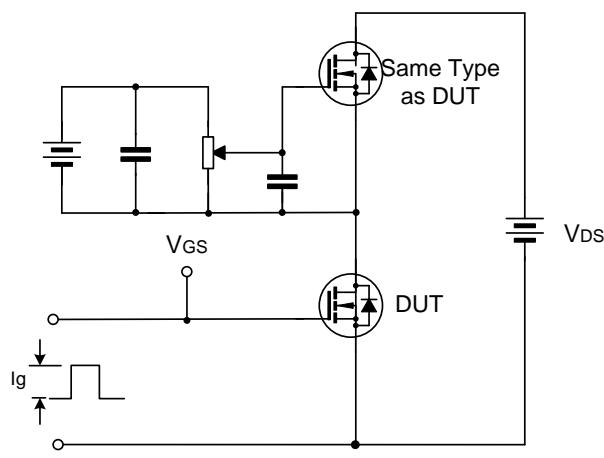


Figure 10. Maximum Drain Current vs. Case Temperature

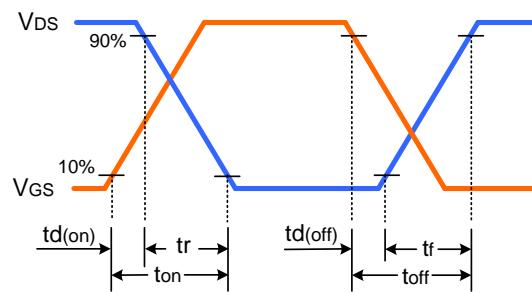
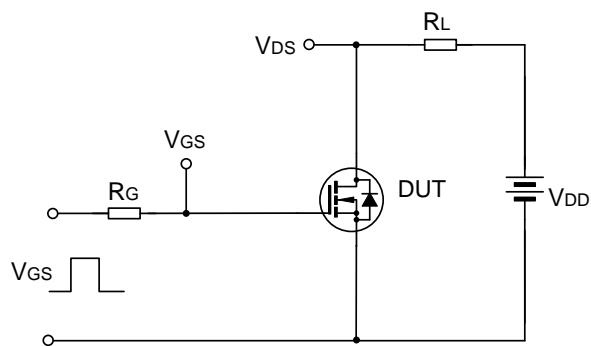


TYPICAL TEST CIRCUIT

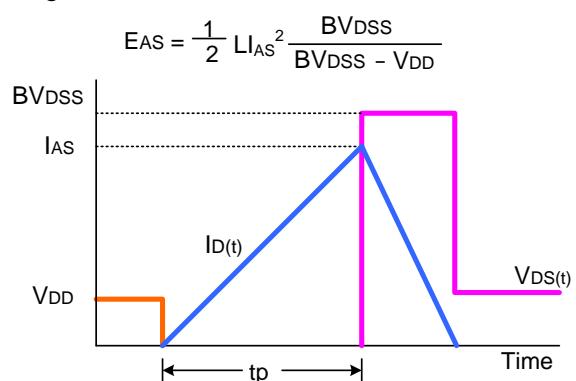
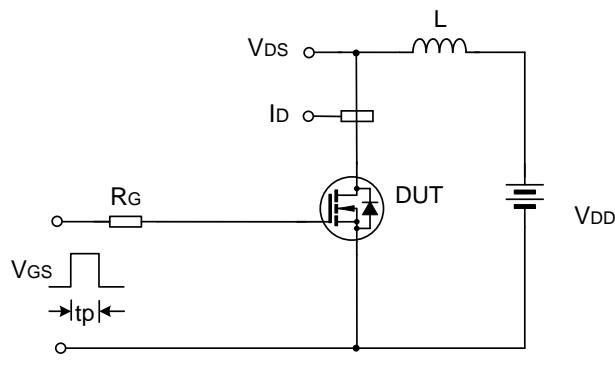
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform

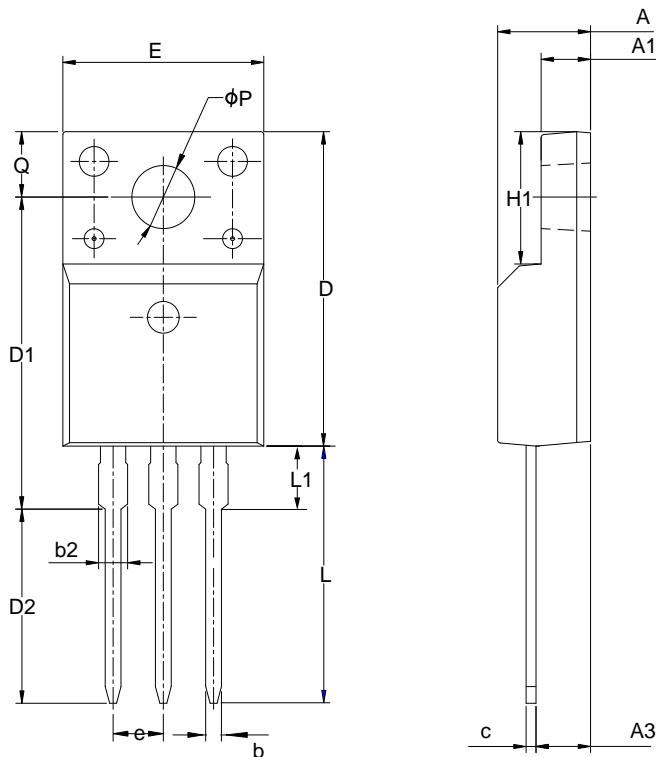




PACKAGE OUTLINE

TO-220F-3L

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.70	0.80	0.90
b2	—	—	1.47
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	15.30	15.75	16.30
D2	9.30	9.80	10.30
E	9.73	10.16	10.36
e	2.54BSC		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	3.50
φP	3.00	3.18	3.40
Q	3.05	3.30	3.55

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Rev.: **2.1**

Revision History:

1. Modify Electrical schematic and typical test circuit
 2. Update the template of the datasheet
-

Rev.: **2.0**

Revision History:

1. Modify the package information of TO-220F-3L
-

Rev.: **1.9**

Revision History:

1. Modify the thermal characteristics
-

Rev.: **1.8**

Revision History:

1. Modify the ordering information
-

Rev.: **1.7**

Revision History:

1. Change the schematic diagram of MOS
-

Rev.: **1.6**

Revision History:

1. Modify the electrical characteristics
-

Rev.: **1.5**

Revision History:

1. Modify the electrical characteristics
-

Rev.: **1.4**

Revision History:

1. Delete the packages of TO-251J-3L and TO-252-2L
-

Rev.: **1.3**

Revision History:

1. Add the package of TO-252-2L
-

Rev.: **1.2**

Revision History:

1. Modify the values of Trr and Qrr
-

Rev.: **1.1**

Revision History:

1. Add the package of TO-251J-3L
-

Rev.: **1.0**

Revision History:

1. Original
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